

#### **DATA SHEET**

# SKY67130-396LF: 0.7-2.7 GHz High Linearity Amplifier Driver

## **Applications**

- LTE, CDMA, WCDMA, and TD-SCDMA cellular infrastructures
- Linear amplifier systems that require high OIP3 with extremely low current
- Ideal for 2.7 to 5.0 V WLAN driver PAs and cellular repeater systems

#### **Features**

- Ultra efficient linear performance
- High OIP3 performance at 2600 MHz: +39 dBm with 3.3 V and 22 mA
- Low Noise Figure: 2.6 dB @ 2.6 GHz and 22 mA
- Adjustable supply current
- Power-down capability
- Unconditionally stable to 24 GHz
- Temperature and process-stable active bias
- Miniature DFN (8-pin, 2 x 2 mm) package (MSL1 @ 260 °C per JEDEC J-STD-020)





Skyworks Green<sup>TM</sup> products are compliant with all applicable legislation and are halogen-free. For additional information, refer to *Skyworks Definition of Green*  $^{TM}$ , document number SQ04-0074.

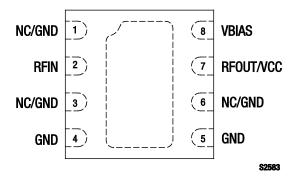


Figure 2. SKY67130-396LF Pinout – 8-Pin DFN (Top View)

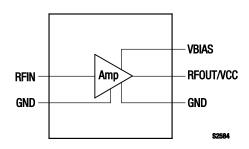


Figure 1. SKY67130-396LF Block Diagram

#### **Description**

The SKY67130-396LF is an InGaP HBT linear amplifier driver with an active bias and superior low-current performance. The advanced InGaP HBT process provides excellent return loss, low noise, and high linearity. The internal active bias circuitry provides stable performance over temperature and process variation.

The supply current can be adjusted, independent of the supply voltage, using the VBIAS signal (pin 8). The VBIAS pin should be connected to the control voltage through an external resistor to control the collector current. The RFIN and RFOUT/VCC pins should be DC blocked to ensure proper operation.

The SKY67130-396LF is manufactured in a compact,  $2 \times 2$  mm, 8-pin Dual Flat No-Lead (DFN) package. A functional block diagram is shown in Figure 1. The pin configuration and package are shown in Figure 2. Signal pin assignments and functional pin descriptions are provided in Table 1.

Table 1. SKY67130-396LF Signal Descriptions

Pin#	Name	Description	Pin#	Name	Description
1	NC or GND	No connection. May be connected to ground with no change in performance.	5	GND	Connect to ground through a low impedance path.
2	RFIN	RF input. DC blocking capacitor required.	6	NC or GND	No connection required. May be connected to ground with no change in performance.
3	NC or GND	No connection. May be connected to ground with no change in performance.	7	RFOUT/VCC	RF output. Apply VCC through RF choke inductor. No DC blocking capacitor required.
4	GND	Connect to ground through a low impedance path.	8	VBIAS	Sets LNA quiescent current

#### Table 2. SKY67130-396LF Absolute Maximum Ratings (Note 1)

Parameter	Symbol	Minimum	Typical	Maximum	Units
Supply voltage	Vcc			5.5	V
Quiescent current	Ica			45	mA
Dissipated power (Note 2)	Poiss			150	mW
RF input power	Pin			+20	dBm
Storage temperature	Тѕтс	-65	+25	+150	°C
Operating temperature	Та	-40	+25	+85	°C
Junction temperature	TJ			+150	°C

**Note:** Exposure to maximum rating conditions for extended periods may reduce device reliability. There is no damage to device with only one parameter set at the limit and all other parameters set at or below their nominal value. Exceeding any of the limits listed here may result in permanent damage to the device.

Note 2: Dissipated power is equal to supply voltage (Vcc) multiplied by the quiescent current (Icq).

**CAUTION**: Although this device is designed to be as robust as possible, Electrostatic Discharge (ESD) can damage this device. This device must be protected at all times from ESD. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection. Industry-standard ESD precautions should be used at all times. The SKY67130-396LF is a Human Body Model (HBM) Class 1A ESD device.

### **Electrical and Mechanical Specifications**

The absolute maximum ratings of the SKY67130-396LF are provided in Table 2. Electrical specifications are provided in Tables 3 and 4.

Typical performance characteristics of the SKY67130-396LF are illustrated in Figures 3 through 27.

Table 3. SKY67130-396LF Electrical Specifications: 3.3 V Operation (Note 1) (Vcc = 3.3 V, Icq = 22 mA, TA = +25 °C, PiN = -13 dBm, Characteristic Impedance [Zo] = 50  $\Omega$ , Unless Otherwise Noted)

Parameter	Symbol	Test Condition	Min	Typical	Max	Units
RF Specifications						
Noise Figure (Note 2)	NF	@ 2.6 GHz, quiescent current = 22 mA		2.6		dB
Small signal gain	IS21I	@ 2.6 GHz		13		dB
Input return loss	IS11I	@ 2.6 GHz		15		dB
Output return loss	IS22l	@ 2.6 GHz		25		dB
Reverse isolation	IS12l	@ 2.6 GHz		19		dB
3 <sup>rd</sup> Order Input Intercept Point	IIP3	@ 2.6 GHz, $\Delta f = \pm 1$ MHz, P <sub>IN</sub> = -14 dBm/tone		+26		dBm
3 <sup>rd</sup> Order Output Intercept Point	OIP3	@ 2.6 GHz, $\Delta f = \pm 1$ MHz, P <sub>IN</sub> = -14 dBm/tone		+39		dBm
1 dB Input Compression Point	IP1dB	@ 2.6 GHz		+4		dBm
1 dB Output Compression Point	OP1dB	@ 2.6 GHz		+16		dBm
DC Specifications						
Supply voltage	Vcc			3.3		V
Quiescent current	Ica	Set with external resistor in series with VBIAS		22		mA
Maximum junction temperature (+85 °C heat sink temperature)	Тумах	3.3 V and 22 mA quiescent current		103		°C
Thermal resistance	Өлс			250		°C/W

Note 1: Performance is guaranteed only under the conditions listed in this Table.

Note 2 Board and connector losses have not been de-embedded.

Table 4. SKY67130-396LF Electrical Specifications: 5.0 V Operation (1 of 2) (Note 1) (Vcc = 5.0 V, Icq = 22 mA, TA = +25 °C, PIN = -13 dBm, Characteristic Impedance [Zo] = 50  $\Omega$ , Unless Otherwise Noted)

Parameter	Symbol	Test Condition	Min	Typical	Max	Units		
RF Specifications								
Noise Figure (Note 2)	NF	@ 2.6 GHz		2.6		dB		
Small signal gain	IS21I	@ 2.6 GHz		13		dB		
Input return loss	IS11I	@ 2.6 GHz		15		dB		
Output return loss	IS22l	@ 2.6 GHz		20		dB		
Reverse isolation	IS12I	@ 2.6 GHz		19		dB		
3 <sup>rd</sup> Order Input Intercept Point	IIP3	@ 2.6 GHz, $\Delta f = \pm 1$ MHz, P <sub>IN</sub> = -14 dBm/tone		+24		dBm		
3 <sup>rd</sup> Order Output Intercept Point	OIP3	@ 2.6 GHz, $\Delta f = \pm 1$ MHz, P <sub>IN</sub> = -14 dBm/tone		+37		dBm		
1 dB Input Compression Point	IP1dB	@ 2.6 GHz		+7		dBm		
1 dB Output Compression Point	OP1dB	@ 2.6 GHz		+19		dBm		

Table 4. SKY67130-396LF Electrical Specifications: 5.0 V Operation (2 of 2) (Note 1) (Vcc = 5.0 V, Icq = 22 mA, TA = +25 °C, PIN = -13 dBm, Characteristic Impedance [Zo] = 50  $\Omega$ , Unless Otherwise Noted)

		· -		-			
Parameter	Symbol	Test Condition	Min	Typical	Max	Units	
DC Specifications							
Supply voltage	Vcc			5.0		٧	
Quiescent current	Ico	Set with external resistor in series with VBIAS		22		mA	
Maximum junction temperature (+85 °C heat sink temperature)	Тумах	5.0 V and 22 mA quiescent current		113		°C	
Thermal resistance	Өлс			250		°C/W	

Note 1: Performance is guaranteed only under the conditions listed in this Table.

Note 2 Board and connector losses have not been de-embedded.

## **Typical Performance Characteristics**

(Vcc = 3.3 V, Icq = 22 mA, f = 2.5 to 2.7 GHz, Standard Evaluation Board Matching, Characteristic Impedance [Zo] = 50  $\Omega$ , Unless Otherwise Noted)

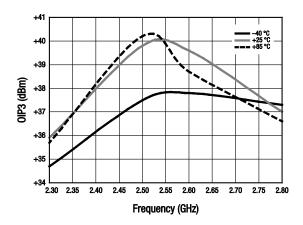


Figure 3. OIP3 vs Frequency Over Temperature

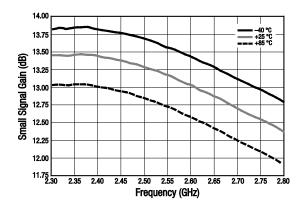


Figure 5. Small Signal Gain (Narrow Band) vs Frequency Over Temperature

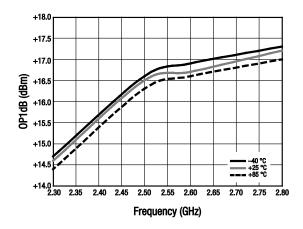


Figure 4. OP1dB vs Frequency Over Temperature

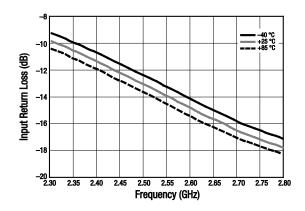


Figure 6. Input Return Loss vs Frequency (Narrow Band) Over Temperature

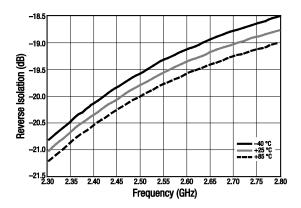
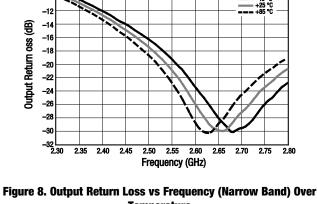


Figure 7. Reverse Isolation vs Frequency (Narrow Band) Over **Temperature** 



**Temperature** 

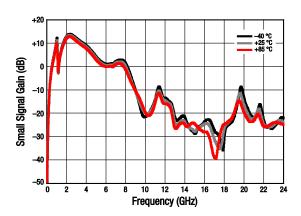


Figure 9. Small Signal Gain vs Frequency (Wide Band) Over **Temperature** 

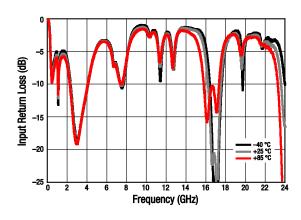


Figure 10. Input Return Loss vs Frequency (Wide Band) Over **Temperature** 

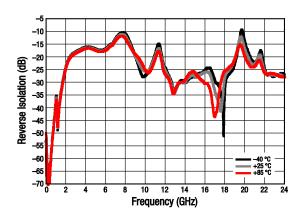


Figure 11. Reverse Isolation vs Frequency (Wide Band) Over **Temperature** 

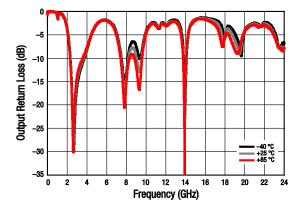


Figure 12. Output Return Loss vs Frequency (Wide Band) Over **Temperature** 

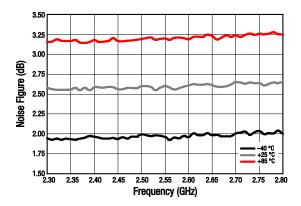


Figure 13. Noise Figure vs Frequency Over Temperature (Includes EVB Losses)

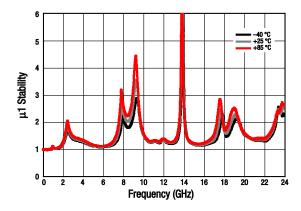


Figure 14.  $\mu$ 1 Stability vs Frequency Over Temperature

# **Typical Performance Characteristics**

(VBIAS = 5.0 V, Icc = 22 mA, f = 2.5 to 2.7 GHz, Standard Evaluation Board Matching, Characteristic Impedance [Zo] = 50  $\Omega$ , Unless Otherwise Noted)

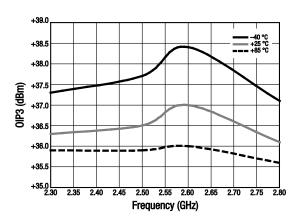


Figure 15. 0IP3 vs Frequency Over Temperature

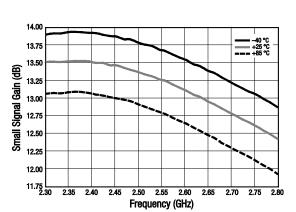


Figure 17. Small Signal Gain vs Frequency (Narrow Band) Over Temperature

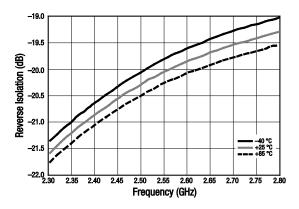


Figure 19. Reverse Isolation vs Frequency (Narrow Band) Over Temperature

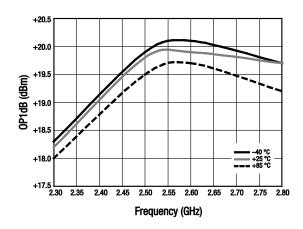


Figure 16. OP1dB vs Frequency Over Temperature

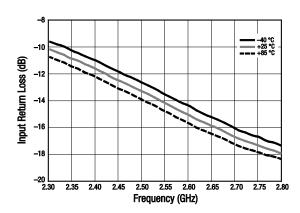


Figure 18. Input Return Loss vs Frequency (Narrow Band) Over Temperature

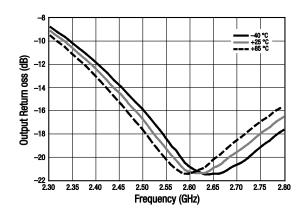


Figure 20. Output Return Loss vs Frequency (Narrow Band) Over Temperature

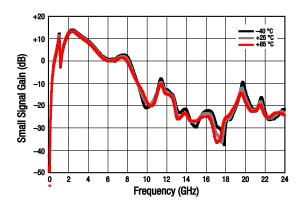
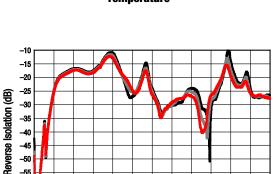


Figure 21. Small Signal Gain vs Frequency (Wide Band) Over **Temperature** 



-50 -55 -60

-65

Figure 23. Reverse Isolation vs Frequency (Wide Band) Over **Temperature** 

12 14

Frequency (GHz)

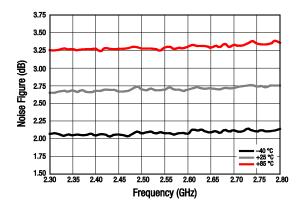


Figure 25. Noise Figure vs Frequency Over Temperature (Includes EVB Losses)

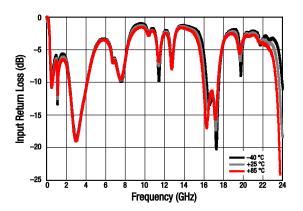


Figure 22. Input Return Loss vs Frequency (Wide Band) Over **Temperature** 

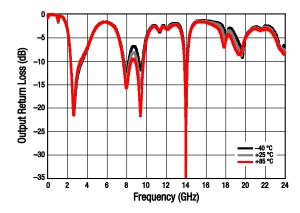


Figure 24. Output Return Loss vs Frequency (Wide Band) Over **Temperature** 

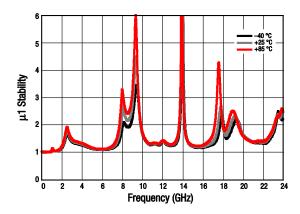


Figure 26. µ1 Stability vs Frequency Over Temperature

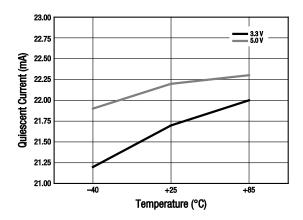


Figure 27. Quiescent Current vs Temperature Over Voltage

#### **Evaluation Board Description**

The SKY67130-396LF Evaluation Board is used to test the performance of the SKY67130-396LF LNA. An assembly drawing for the Evaluation Board is shown in Figure 28. An Evaluation Board schematic diagram is provided in Figure 29. Table 5 provides the Bill of Materials (BOM) list for Evaluation Board 2.6 GHz matching components.

The test board uses a 10 mil Rogers 4350B substrate on a 50 mil FR4 supporting substrate. The Rogers 4350B material was selected for the RF circuit because of its low dielectric constant ( $\varepsilon_r$ ) and low  $\varepsilon_r$  variation over temperature for the best possible noise performance.

# **Package Dimensions**

The PCB layout footprint for the SKY67130-396LF is provided in Figure 30. Typical case markings are shown in Figure 31. Package dimensions for the 8-pin DFN are shown in Figure 32, and tape and reel dimensions are provided in Figure 33.

# **Package and Handling Information**

Instructions on the shipping container label regarding exposure to moisture after the container seal is broken must be followed. Otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly.

THE SKY67130-396LF is rated to Moisture Sensitivity Level 1 (MSL1) at 260 °C. It can be used for lead or lead-free soldering. For additional information, refer to the Skyworks Application Note, *Solder Reflow Information*, document number 200164.

Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. Production quantities of this product are shipped in a standard tape and reel format.

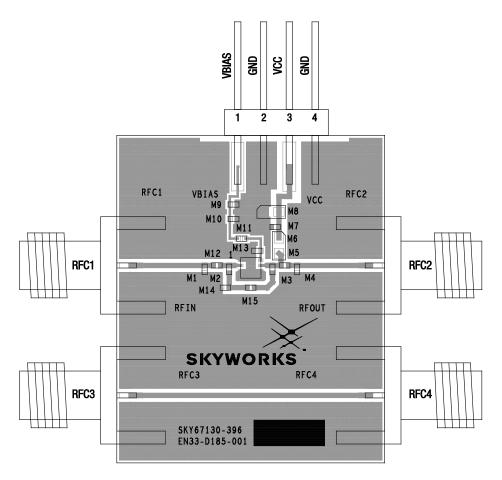


Figure 28. SKY67130-396LF Evaluation Board Assembly Diagram

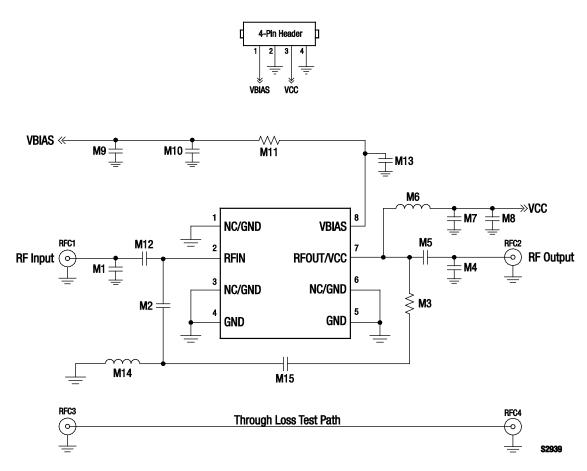


Figure 29. SKY67130-396LF Evaluation Board Schematic

Table 5. SKY67130-396LF Evaluation Board Bill of Materials: 2.5 to 2.7 GHz Matching Components

Component	Value	Size	Manufacturer
M1	DNI	0402	-
M2	0.1 μF	0402	Murata GRM
M3	DNI	0402	-
M4	DNI	0402	-
M5	1.2 pF	0402	Murata GJM
M6	1.8 nH	0402	Murata LQG
M7	22 pF	0402	Murata GRM
M8	1 μF	0402	Murata GRM
M9	1 μF	0402	Murata GRM
M10	100 pF	0402	Murata GRM
M11	360 Ω	0402	Kamaya RMC 1/16S 5%
M12	8.2 pF	0402	Murata GJM
M13	DNI	0402	-
M14	8.2 nH	0402	Murata LQG
M15	DNI	0402	-

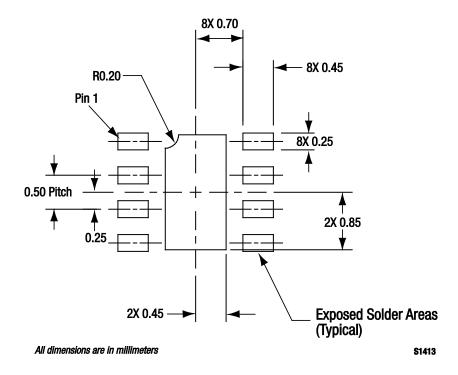


Figure 30. SKY67130-396LF PCB Layout Footprint (Top View)

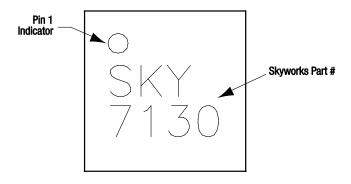
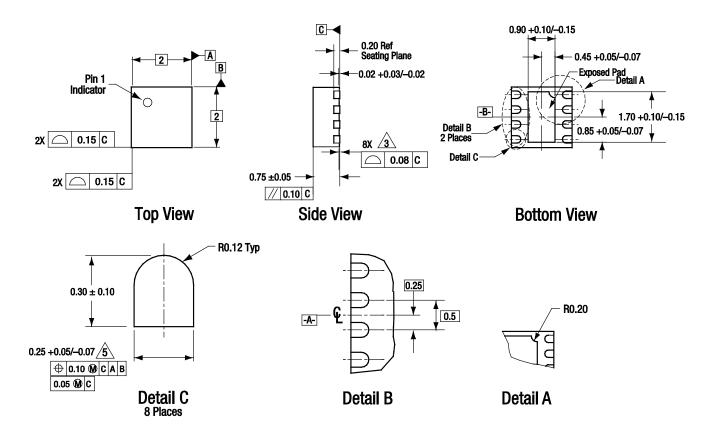


Figure 31. Typical Case Markings (Top View)



All measurements are in millimeters.

Dimensioning and tolerancing according to ASME Y14.5M-1994.

Coplanarity applies to the exposed heat sink stug as well as the terminals.. Platting requirement per source control drawing (SCD) 2504. Dimension applies to metalized terminal and is measured between 0.15 m ured between 0.15 mm and 0.30 mm from terminal tip.

S1945

Figure 32. SKY67130-396LF 8-Pin DFN Package Dimensions

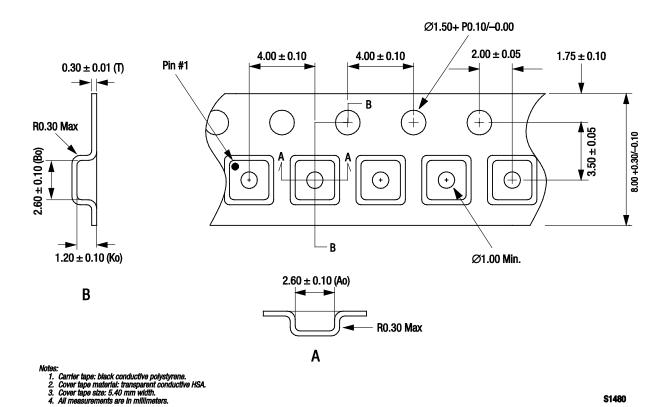


Figure 33. SKY67130-396LF Tape and Reel Dimensions

#### **Ordering Information**

Model Name	Manufacturing Part Number	<b>Evaluation Board Part Number</b>	
SKY67130-396LF LNA	SKY67130-396LF	SKY67130-396LF-EVB	

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